![Texas Instruments logo] **TEXAS INSTRUMENTS**

ADS7822-Q1

12-BIT 200-kHz MICROPOWER SAMPLING ANALOG-TO-DIGITAL CONVERTER

FEATURES

- **Qualified for Automotive Applications**
- **200-kHz Sampling Rate**
- **Micropower:**
  1.6 mW at 200 kHz
  0.54 mW at 75 kHz
  0.06 mW at 7.5 kHz
- **Power-Down Current: 3 μA Max**
- **MSOP-8 Package**
- **Pseudo-Differential Input**
- **Serial Interface**

APPLICATIONS

- **Battery-Operated Systems**
- **Remote Data Acquisition**
- **Isolated Data Acquisition**
- **Simultaneous Sampling, Multichannel Systems**

DESCRIPTION

The ADS7822 is a 12-bit sampling analog-to-digital (A/D) converter with ensured specifications over a 2.7-V to 5.25-V supply range. It requires very little power even when operating at the full 200-kHz rate. At lower conversion rates, the high speed of the device enables it to spend most of its time in the power-down mode—the power dissipation is less than 60 μW at 7.5 kHz.

The ADS7822 also features operation from 2.0 V to 5 V, a synchronous serial interface, and a pseudo-differential input. The reference voltage can be set to any level within the range of 50 mV to V_{CC}.

Ultra low power and small size make the ADS7822 ideal for battery-operated systems. It is also a perfect fit for remote data-acquisition modules, simultaneous multichannel systems, and isolated data acquisition. The ADS7822 is available in an MSOP-8 package.
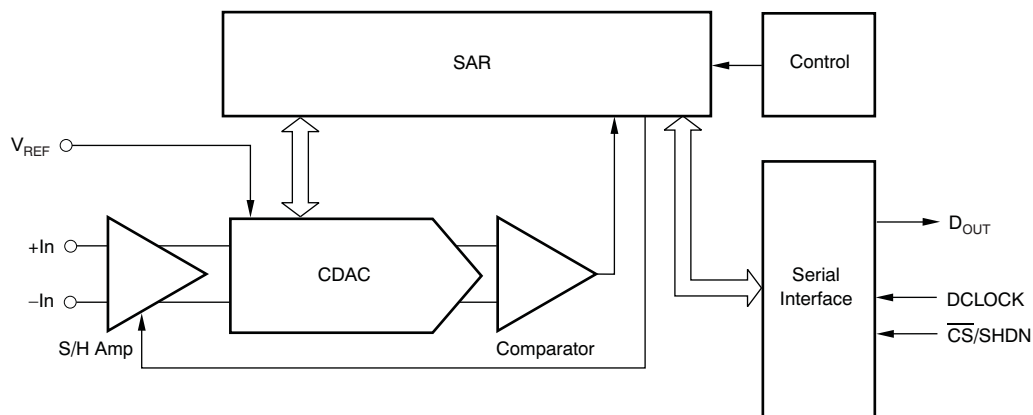
This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION[1]

T_A	PACKAGE[2]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
−40°C to 85°C	MSOP – DGK	Reel of 2500	ADS7822IDGKRQ1	OCV

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

ABSOLUTE MAXIMUM RATINGS[1]

over operating free-air temperature range (unless otherwise noted)

V_{CC}	Supply voltage		6 V
V_{IN}	Input voltage	Analog inputs	−0.3 V to V_{CC} + 0.3 V
		Logic inputs	−0.3 V to 6 V
T_C	Case temperature		100°C
T_J	Junction temperature		150°C
T_{STG}	Storage temperature		125°C
V_{REF}	External reference voltage		5.5 V

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS: +V$_{CC}$ = 2.7 V

At −40°C to 85°C, +V$_{CC}$ = 2.7 V, V$_{REF}$ = 2.5 V, f$_{SAMPLE}$ = 75 kHz, and f$_{CLK}$ = 16 × f$_{SAMPLE}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALOG INPUT						
Full-scale input span		+In − (−In)	0		V$_{REF}$	V
Absolute input range		+In − GND	−0.2		V$_{CC}$ + 0.2	V
		−In − GND	−0.2		+1.0	V
Capacitance				25		pF
Leakage current				±1		µA
SYSTEM PERFORMANCE						
Resolution				12		Bits
No missing codes			11			Bits
Integral linearity error			−2	±0.5	+2	LSB[1]
Differential linearity error			−2	±0.5	+2	LSB
Offset error			−3		+3	LSB
Gain error			−3		+3	LSB
Noise				33		µVrms
Power-supply rejection				82		dB
SAMPLING DYNAMICS						
Conversion time				12		Clk Cycles
Acquisition time[2]			1.5			Clk Cycles
Throughput rate					75	kHz
DYNAMIC CHARACTERISTICS						
Total harmonic distortion		V$_{IN}$ = 2.5 V$_{PP}$ at 1 kHz		−82		dB
SINAD		V$_{IN}$ = 2.5 V$_{PP}$ at 1 kHz		71		dB
Spurious-free dynamic range		V$_{IN}$ = 2.5 V$_{PP}$ at 1 kHz		86		dB
REFERENCE OUTPUT						
Voltage range			0.05		V$_{CC}$	V
Resistance		$\overline{CS}$ = GND, f$_{SAMPLE}$ = 0 Hz		5		GΩ
		$\overline{CS}$ = V$_{CC}$		5		GΩ
Current drain		At code 710h		8	40	µA
		f$_{SAMPLE}$ = 7.5 kHz		0.8		µA
		$\overline{CS}$ = V$_{CC}$		0.001	3	µA
DIGITAL INPUT/OUTPUT						
Logic family				CMOS		
Logic levels	V$_{IH}$	I$_{IH}$ = +5 µA	2.0		5.5	V
	V$_{IL}$	I$_{IL}$ = +5 µA	−0.3		0.8	V
	V$_{OH}$	I$_{OH}$ = −250 µA	2.1			V
	V$_{OL}$	I$_{OL}$ = 250 µA			0.4	V
Data format				Straight Binary		

(1) LSB means least significant bit. With V$_{REF}$ equal to 2.5 V, one LSB is 0.61 mV.
(2) Not production tested

ELECTRICAL CHARACTERISTICS: +V_{CC} = 2.7 V (continued)

At −40°C to 85°C, +V_{CC} = 2.7 V, V_{REF} = 2.5 V, f_{SAMPLE} = 75 kHz, and f_{CLK} = 16 × f_{SAMPLE} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER-SUPPLY REQUIREMENTS					
V_{CC}	Specified performance	2.7		3.6	V
	See Notes [3] and [4]	2.0		2.7	V
	See Note [4]	2.7		3.6	V
Quiescent current	f_{SAMPLE} = 7.5 kHz [5][6]		20		µA
	f_{SAMPLE} = 75 kHz [6]		200	325	µA
Power down current	$\overline{CS}$ = V_{CC}			10	µA
TEMPERATURE RANGE					
Specified performance		−40		85	°C

(3)   The maximum clock rate of the ADS7822 is less than 1.2 MHz in this power-supply range.
(4)   See the Typical Characteristics for more information.
(5) f_{CLK} = 1.2 MHz, $\overline{CS}$ = V_{CC} for 145 clock cycles out of every 160.
(6)   See the Power Dissipation section for more information regarding lower sample rates.

Product Folder Link(s): *ADS7822-Q1*

ELECTRICAL CHARACTERISTICS: +V$_{CC}$ = 5 V

At −40°C to 85°C, +V$_{CC}$ = 5 V, V$_{REF}$ = 5 V, f$_{SAMPLE}$ = 200 kHz, and f$_{CLK}$ = 16 × f$_{SAMPLE}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALOG INPUT						
Full-scale input span		+In − (−In)	0		V$_{REF}$	V
Absolute input range		+In − GND	−0.2		V$_{CC}$ + 0.2	V
		−In − GND	−0.2		+1.0	V
Capacitance				25		pF
Leakage current				±1		µA
SYSTEM PERFORMANCE						
Resolution				12		Bits
No missing codes			11			Bits
Integral linearity error			−2		+2	LSB[1]
Differential linearity error				±0.8		LSB
Offset error			−3		+3	LSB
Gain error			−4		+4	LSB
Noise				33		µVrms
Power-supply rejection				70		dB
SAMPLING DYNAMICS						
Conversion time				12		Clk Cycles
Acquisition time[2]			1.5			Clk Cycles
Throughput rate					200	kHz
DYNAMIC CHARACTERISTICS						
Total harmonic distortion		V$_{IN}$ = 5 V$_{PP}$ at 10 kHz		−78		dB
SINAD		V$_{IN}$ = 5 V$_{PP}$ at 10 kHz		71		dB
Spurious-free dynamic range		V$_{IN}$ = 5 V$_{PP}$ at 10 kHz		79		dB
REFERENCE OUTPUT						
Voltage range			0.05		V$_{CC}$	V
Resistance		$\overline{CS}$ = GND, f$_{SAMPLE}$ = 0 Hz		5		GΩ
		$\overline{CS}$ = V$_{CC}$		5		GΩ
Current drain		At code 710h		40	100	µA
		f$_{SAMPLE}$ = 12.5 kHz		2.5		µA
		$\overline{CS}$ = V$_{CC}$		0.001	3	µA
DIGITAL INPUT/OUTPUT						
Logic family				CMOS		
Logic levels	V$_{IH}$	I$_{IH}$ = +5 µA	3.0		5.5	V
	V$_{IL}$	I$_{IL}$ = +5 µA	−0.3		0.8	V
	V$_{OH}$	I$_{OH}$ = −250 µA	3.5			V
	V$_{OL}$	I$_{OL}$ = 250 µA			0.4	V
Data format				Straight Binary		
POWER-SUPPLY REQUIREMENTS						
V$_{CC}$		Specified performance	4.75		5.25	V
Quiescent current		f$_{SAMPLE}$ = 200 kHz		320	550	µA
Power down current		$\overline{CS}$ = V$_{CC}$			10	µA
TEMPERATURE RANGE						
Specified performance			−40		85	°C

(1) LSB means least significant bit. With V$_{REF}$ equal to 5 V, one LSB is 1.22 mV.
(2) Not production tested

PIN CONFIGURATION

DGK PACKAGE
(TOP VIEW)

```
         ┌─────────────────┐
VREF  1 │                 │ 8  +VCC
 +In  2 │    ADS7822       │ 7  DCLOCK
 −In  3 │                 │ 6  DOUT
 GND  4 │                 │ 5  CS/SHDN
         └─────────────────┘
```

PIN ASSIGNMENTS

PIN NAME	NO.	DESCRIPTION
V_{REF}	1	Reference input
+In	2	Noninverting input
−In	3	Inverting input. Connect to ground or to remote ground sense point.
GND	4	Ground
$\overline{CS}$/SHDN	5	Chip select when low; shutdown mode when high.
D_{OUT}	6	The serial output data word is comprised of 12 bits of data. In operation, the data are valid on the falling edge of DCLOCK. The second clock pulse after the falling edge of $\overline{CS}$ enables the serial output. After one null bit, the data are valid for the next edges.
DCLOCK	7	Data clock synchronizes the serial data transfer and determines conversion speed.
$+V_{CC}$	8	Power supply

Product Folder Link(s): *ADS7822-Q1*

TYPICAL CHARACTERISTICS

T_A = 25°C, V_{CC} = 2.7 V, V_{REF} = 2.5 V, f_{SAMPLE} = 75 kHz, f_{CLK} = 16 × f_{SAMPLE} (unless otherwise noted)

INTEGRAL LINEARITY ERROR vs CODE

Figure 1.

DIFFERENTIAL LINEARITY ERROR vs CODE

Figure 2.

SUPPLY CURRENT vs TEMPERATURE

Figure 3.

POWER-DOWN SUPPLY CURRENT vs TEMPERATURE

Figure 4.

QUIESCENT CURRENT vs V_{CC}

Figure 5.

MAXIMUM SAMPLE RATE vs V_{CC}
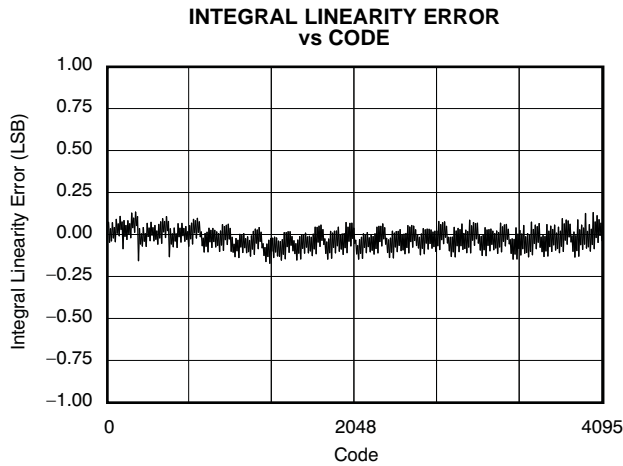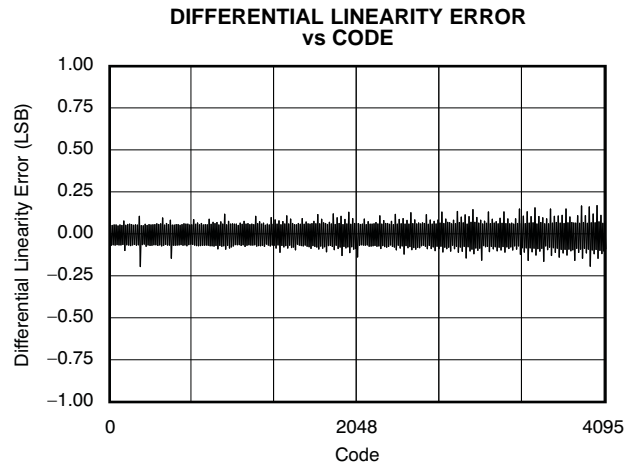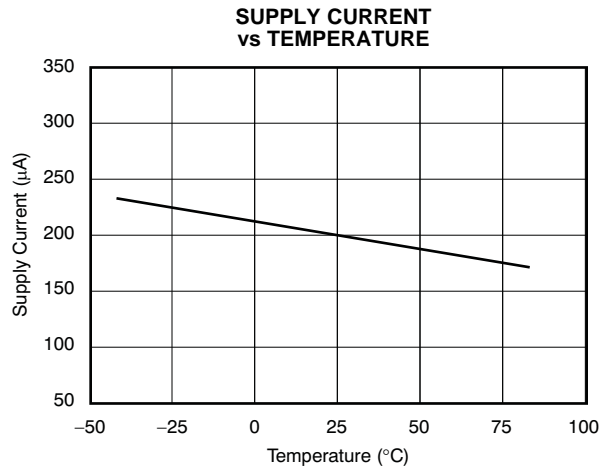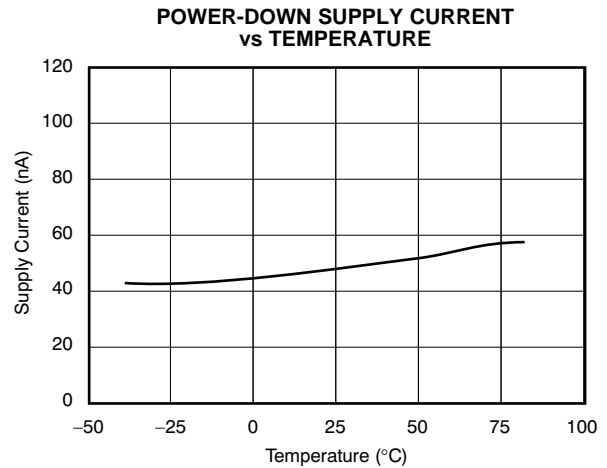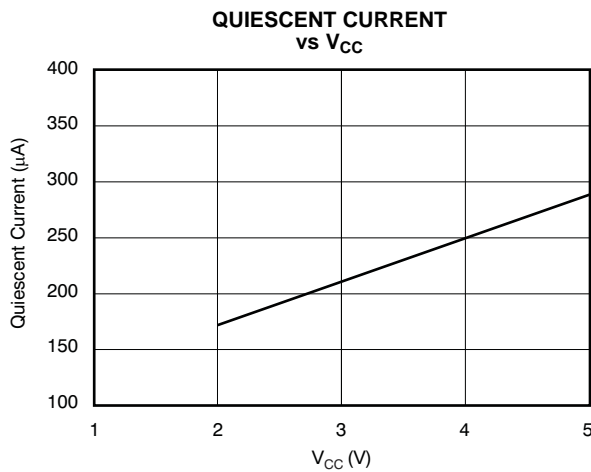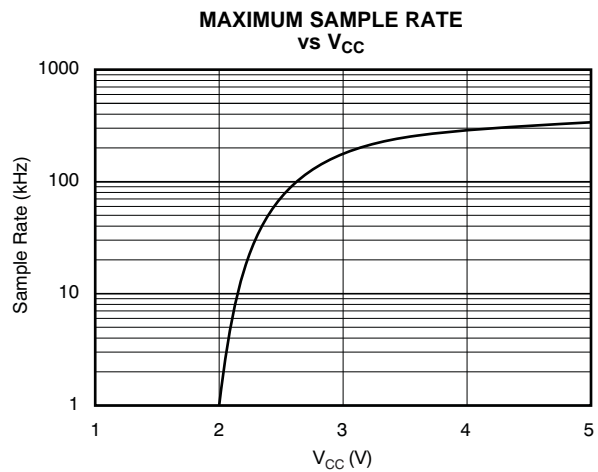
Figure 6.

TYPICAL CHARACTERISTICS (continued)

T_A = 25°C, V_{CC} = 2.7 V, V_{REF} = 2.5 V, f_{SAMPLE} = 75 kHz, f_{CLK} = 16 × f_{SAMPLE} (unless otherwise noted)

**CHANGE IN OFFSET
vs REFERENCE VOLTAGE**

Figure 7.

**CHANGE IN OFFSET
vs TEMPERATURE**

Figure 8.

**CHANGE IN GAIN
vs REFERENCE VOLTAGE**

Figure 9.

**CHANGE IN GAIN
vs TEMPERATURE**

Figure 10.

**EFFECTIVE NUMBER OF BITS
vs REFERENCE VOLTAGE**

Figure 11.

**PEAK-TO-PEAK NOISE
vs REFERENCE VOLTAGE**
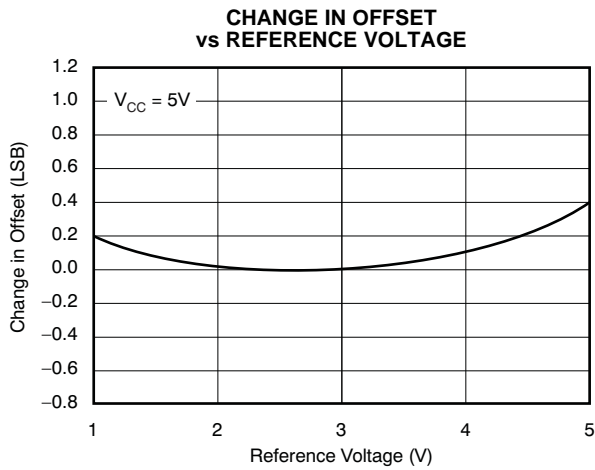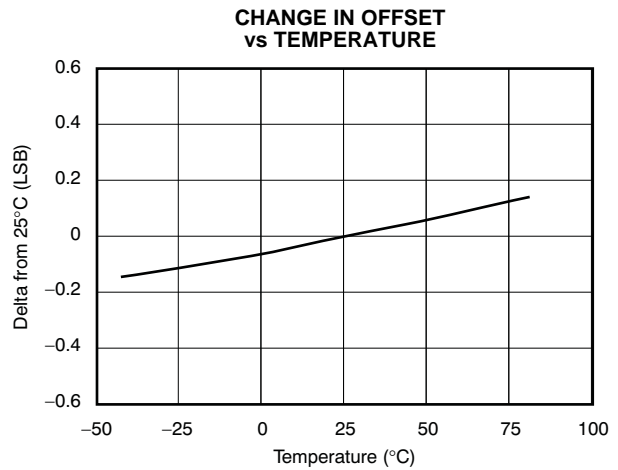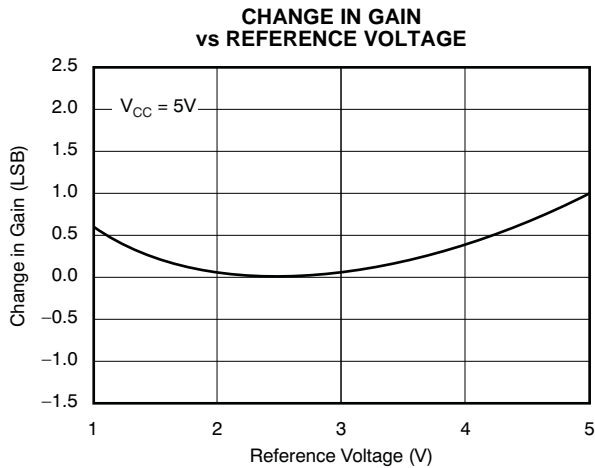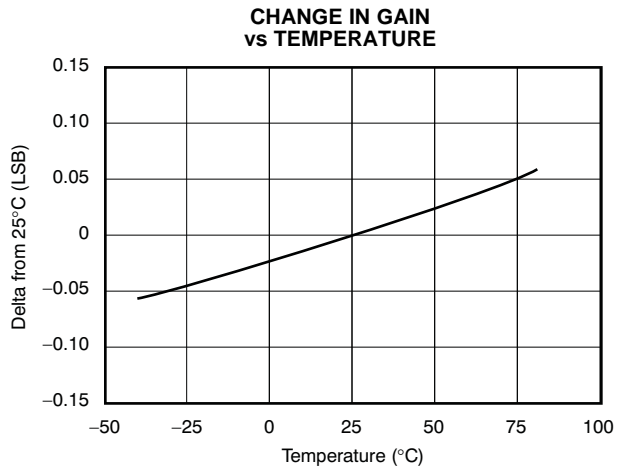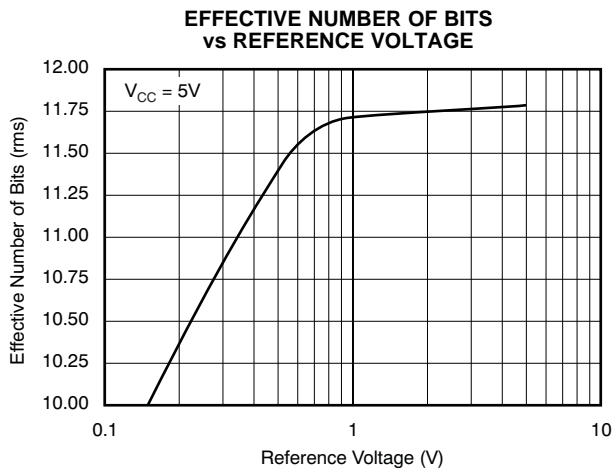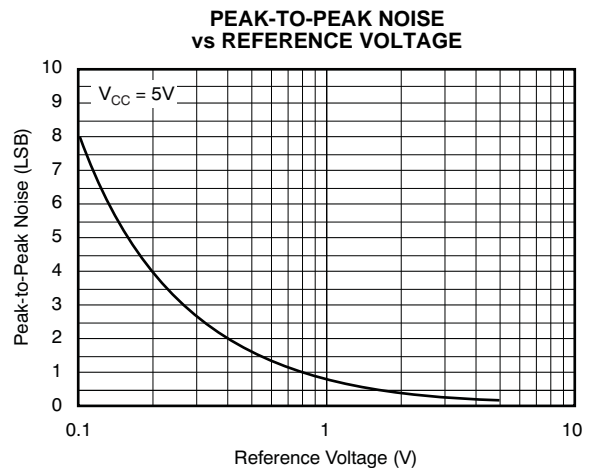
Figure 12.

TYPICAL CHARACTERISTICS (continued)

T_A = 25°C, V_{CC} = 2.7 V, V_{REF} = 2.5 V, f_{SAMPLE} = 75 kHz, f_{CLK} = 16 × f_{SAMPLE} (unless otherwise noted)

SPURIOUS FREE DYNAMIC RANGE AND SIGNAL-TO-NOISE RATIO vs FREQUENCY

Figure 13.

TOTAL HARMONIC DISTORTION vs FREQUENCY

Figure 14.

SIGNAL-TO-(NOISE+DISTORTION) vs FREQUENCY

Figure 15.

SIGNAL-TO-(NOISE+DISTORTION) vs INPUT LEVEL

Figure 16.

REFERENCE CURRENT vs SAMPLE RATE

Figure 17.

REFERENCE CURRENT vs TEMPERATURE (Code = 710h)
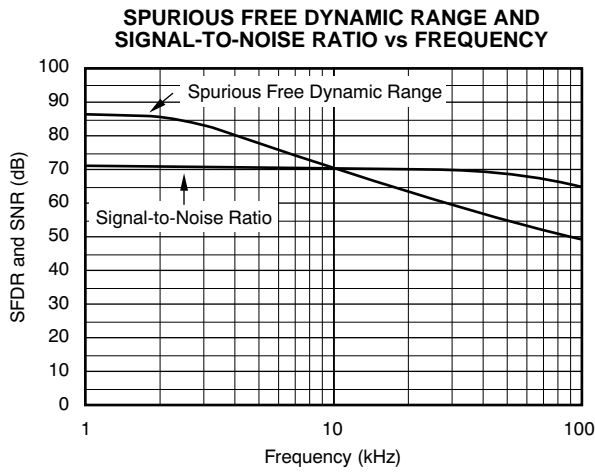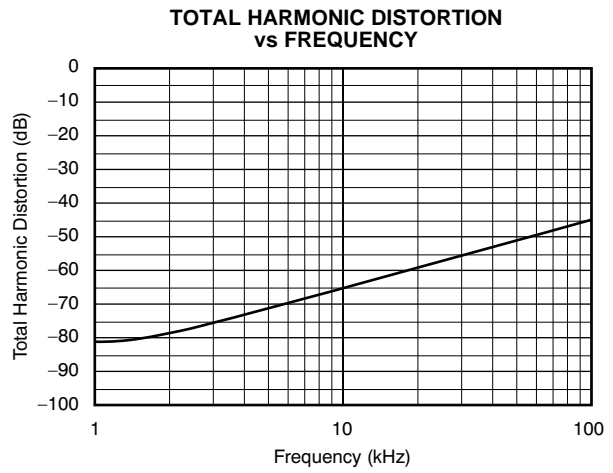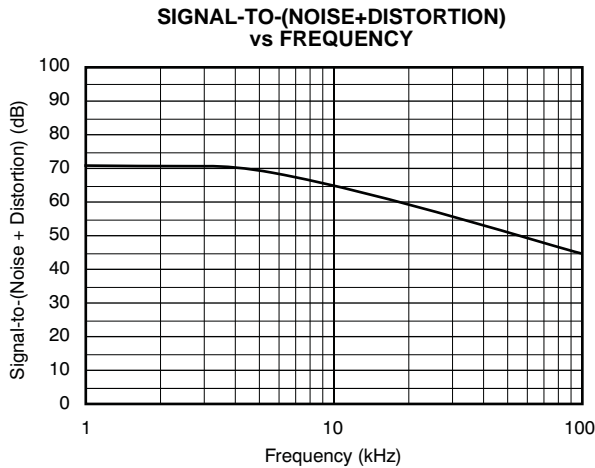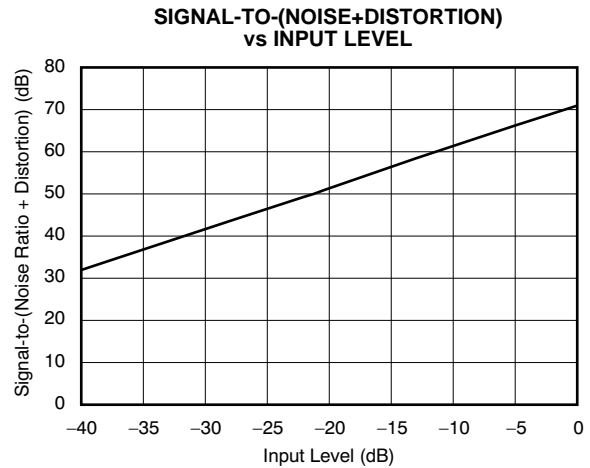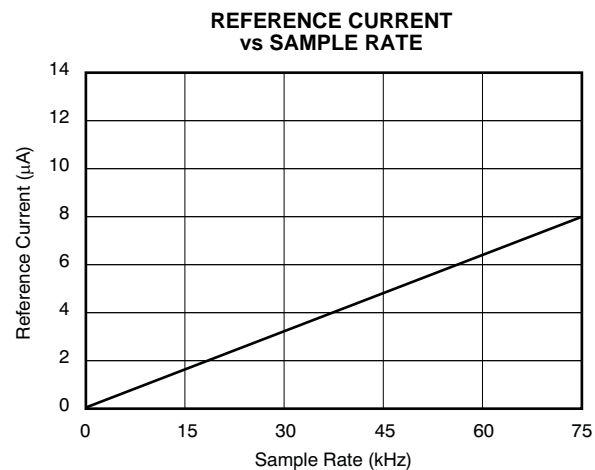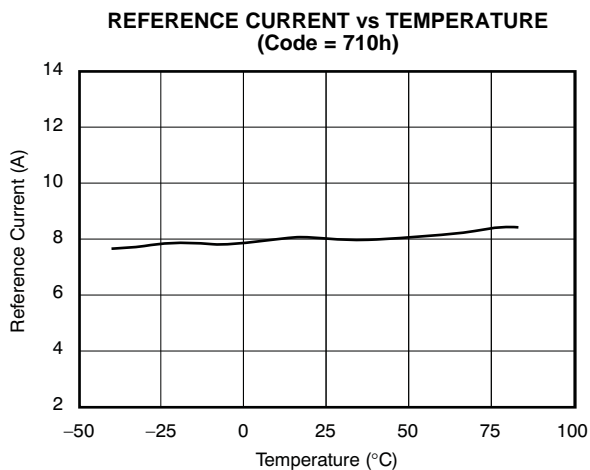
Figure 18.

TYPICAL CHARACTERISTICS (continued)

T_A = 25°C, V_{CC} = 2.7 V, V_{REF} = 2.5 V, f_{SAMPLE} = 75 kHz, f_{CLK} = 16 × f_{SAMPLE} (unless otherwise noted)

**POWER-SUPPLY REJECTION
vs RIPPLE FREQUENCY**

V_{CC} = 2.7V
Ripple = 500mV$_{PP}$
V_{IN} = 1.25VDC
V_{REF} = 2.5V

PSR (dB) = 20log(500mV/ΔV_O)
where ΔV_O = change in digital result

Figure 19.

**POWER-SUPPLY REJECTION
vs RIPPLE FREQUENCY**

V_{CC} = 5V
Ripple = 500mV$_{PP}$
V_{IN} = 2.5VDC
V_{REF} = 5V

PSR (dB) = 20log(500mV/ΔV_O)
where ΔV_O = change in digital result
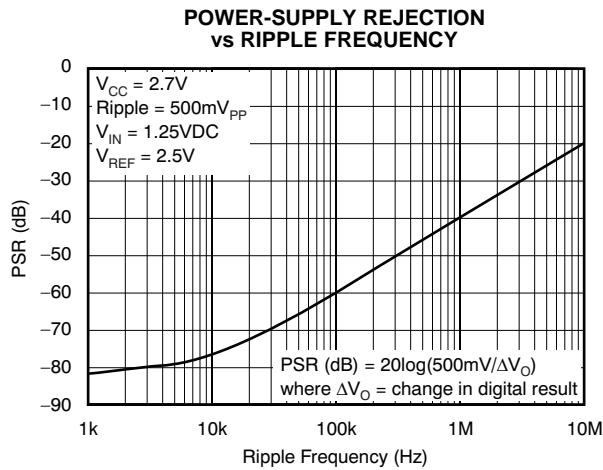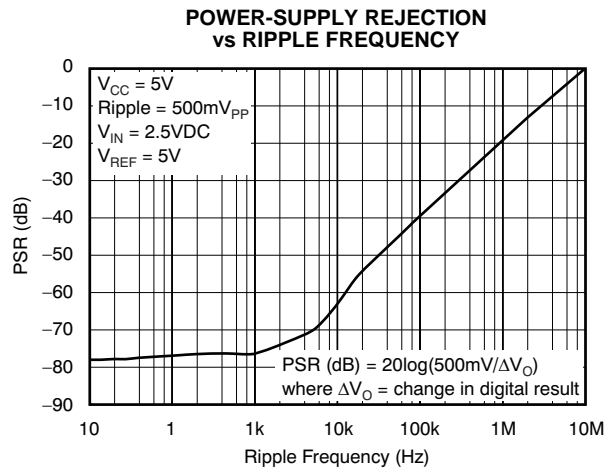
Figure 20.

**CHANGE IN INTEGRAL LINEARITY
AND DIFFERENTIAL LINEARITY
vs REFERENCE VOLTAGE**

V_{CC} = 5V

Change in Integral
Linearity (LSB)

Change in Differential
Linearity (LSB)

Figure 21.
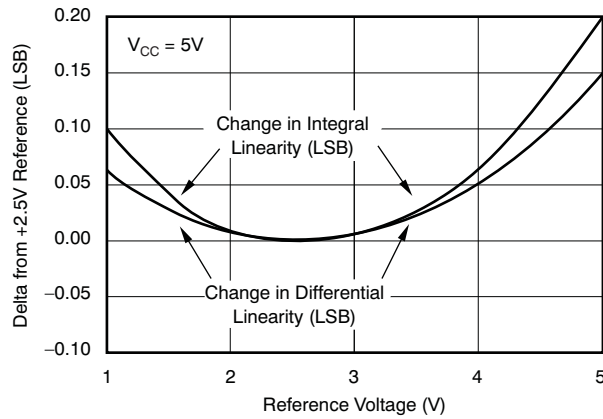
Product Folder Link(s): *ADS7822-Q1*

THEORY OF OPERATION

The ADS7822 is a classic successive approximation register (SAR) A/D converter. The architecture is based on capacitive redistribution that inherently includes a sample/hold function. The converter is fabricated on a 0.6µ CMOS process. The architecture and process allow the ADS7822 to acquire and convert an analog signal at up to 200,000 conversions per second while consuming very little power.

The ADS7822 requires an external reference, an external clock, and a single power source (V_{CC}). The external reference can be any voltage between 50 mV and V_{CC}. The value of the reference voltage directly sets the range of the analog input. The reference input current depends on the conversion rate of the ADS7822.

The external clock can vary between 10 kHz (625 Hz throughput) and 3.2 MHz (200 kHz throughput). The duty cycle of the clock is essentially unimportant as long as the minimum high and low times are at least 400 ns for a supply range between 2.7 V to 3.6 V, or 125 ns for a supply range between 4.75 V to 5.25 V. The minimum clock frequency is set by the leakage on the capacitors internal to the ADS7822.

The analog input is provided to two input pins: +In and −In. When a conversion is initiated, the differential input on these pins is sampled on the internal capacitor array. While a conversion is in progress, both inputs are disconnected from any internal function.

The digital result of the conversion is clocked out by the DCLOCK input and is provided serially, most significant bit first, on the D_{OUT} pin. The digital data that is provided on the D_{OUT} pin is for the conversion currently in progress—there is no pipeline delay. It is possible to continue to clock the ADS7822 after the conversion is complete and to obtain the serial data least significant bit first. See the Digital Interface section for more information.

ANALOG INPUT

The +In and −In input pins allow for a pseudo-differential input signal. Unlike some converters of this type, the −In input is not resampled later in the conversion cycle. When the converter goes into the hold mode, the voltage difference between +In and −In is captured on the internal capacitor array.

The range of the −In input is limited to −0.2 V to 1 V. Because of this, the differential input can be used to reject only small signals that are common to both inputs. Thus, the −In input is best used to sense a remote signal ground that may move slightly with respect to the local ground potential.

The input current on the analog inputs depends on a number of factors: sample rate, input voltage, source impedance, and power-down mode. Essentially, the current into the ADS7822 charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input voltage must be able to charge the input capacitance (25 pF) to a 12-bit settling level within 1.5 clock cycles. When the converter goes into the hold mode or while it is in the power-down mode, the input impedance is greater than 1 GΩ.

Care must be taken regarding the absolute analog input voltage. To maintain the linearity of the converter, the −In input should not drop below GND − 200 mV or exceed GND + 1 V. The +In input should always remain within the range of GND − 200 mV to V_{CC} + 200 mV. Outside of these ranges, the converter linearity may not meet specifications.

REFERENCE INPUT

The external reference sets the analog input range. The ADS7822 operates with a reference in the range of 50 mV to V_{CC}. There are several important implications of this.

As the reference voltage is reduced, the analog voltage weight of each digital output code is reduced. This is often referred to as the LSB (least significant bit) size and is equal to the reference voltage divided by 4096. This means that any offset or gain error inherent in the A/D converter will appear to increase, in terms of LSB size, as the reference voltage is reduced.

The noise inherent in the converter will also appear to increase with lower LSB size. With a 2.5-V reference, the internal noise of the converter typically contributes only 0.32 LSB peak-to-peak of potential error to the output code. When the external reference is 50 mV, the potential error contribution from the internal noise will be 50 times larger—16 LSBs. The errors due to the internal noise are gaussian in nature and can be reduced by averaging consecutive conversion results.

For more information regarding noise, consult the typical characteristic curves Effective Number of Bits vs Reference Voltage and Peak-to-Peak Noise vs Reference Voltage. Note that the effective number of bits (ENOB) figure is calculated based on the converter signal-to-(noise + distortion) ratio with a 1-kHz 0-dB input signal. SINAD is related to ENOB as follows:

$$SINAD = 6.02 \times ENOB + 1.76$$

With lower reference voltages, extra care should be taken to provide a clean layout including adequate bypassing, a clean power supply, a low-noise reference, and a low-noise input signal. Because the LSB size is lower, the converter will also be more sensitive to external sources of error such as nearby digital signals and electromagnetic interference.

DIGITAL INTERFACE

Signal Levels

The digital inputs of the ADS7822 can accommodate logic levels up to 6 V regardless of the value of V_{CC}. Thus, the ADS7822 can be powered at 3V and still accept inputs from logic powered at 5 V.

The CMOS digital output (D_{OUT}) will swing 0 V to V_{CC}. If V_{CC} is 3 V and this output is connected to a 5-V CMOS logic input, then that IC may require more supply current than normal and may have a slightly longer propagation delay.

Serial Interface

The ADS7822 communicates with microprocessors and other digital systems via a synchronous 3-wire serial interface, as shown in Figure 22 and Table 1. The DCLOCK signal synchronizes the data transfer with each bit being transmitted on the falling edge of DCLOCK. Most receiving systems will capture the bitstream on the rising edge of DCLOCK. However, if the minimum hold time for D_{OUT} is acceptable, the system can use the falling edge of DCLOCK to capture each bit.
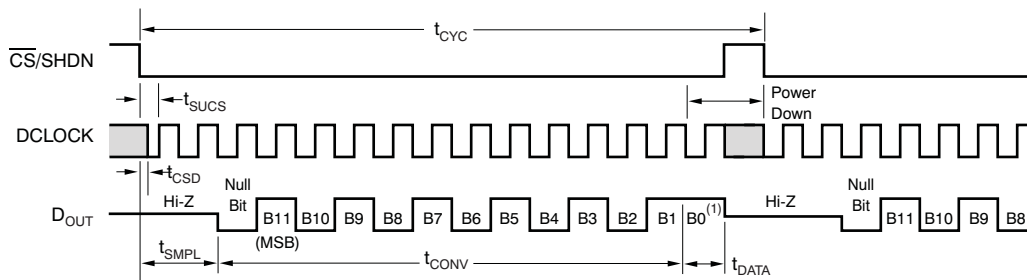
Note: (1) After completing the data transfer, if further clocks are applied with $\overline{CS}$ LOW, the A/D will output LSB-First data then followed with zeroes indefinitely.
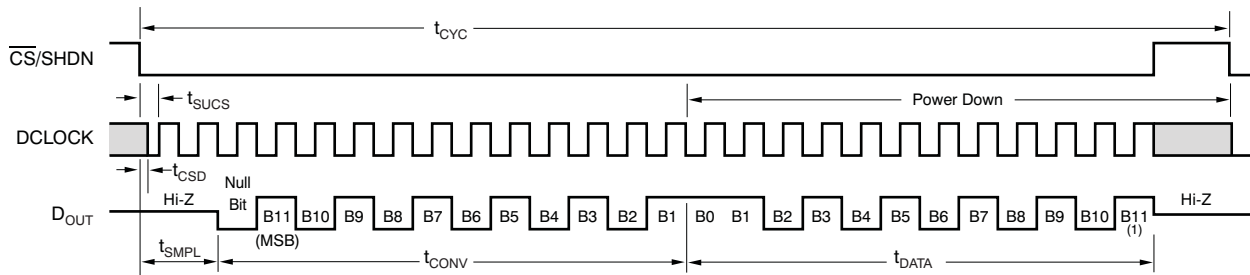
Note: (1) After completing the data transfer, if further clocks are applied with $\overline{CS}$ LOW, the A/D will output zeroes indefinitely.
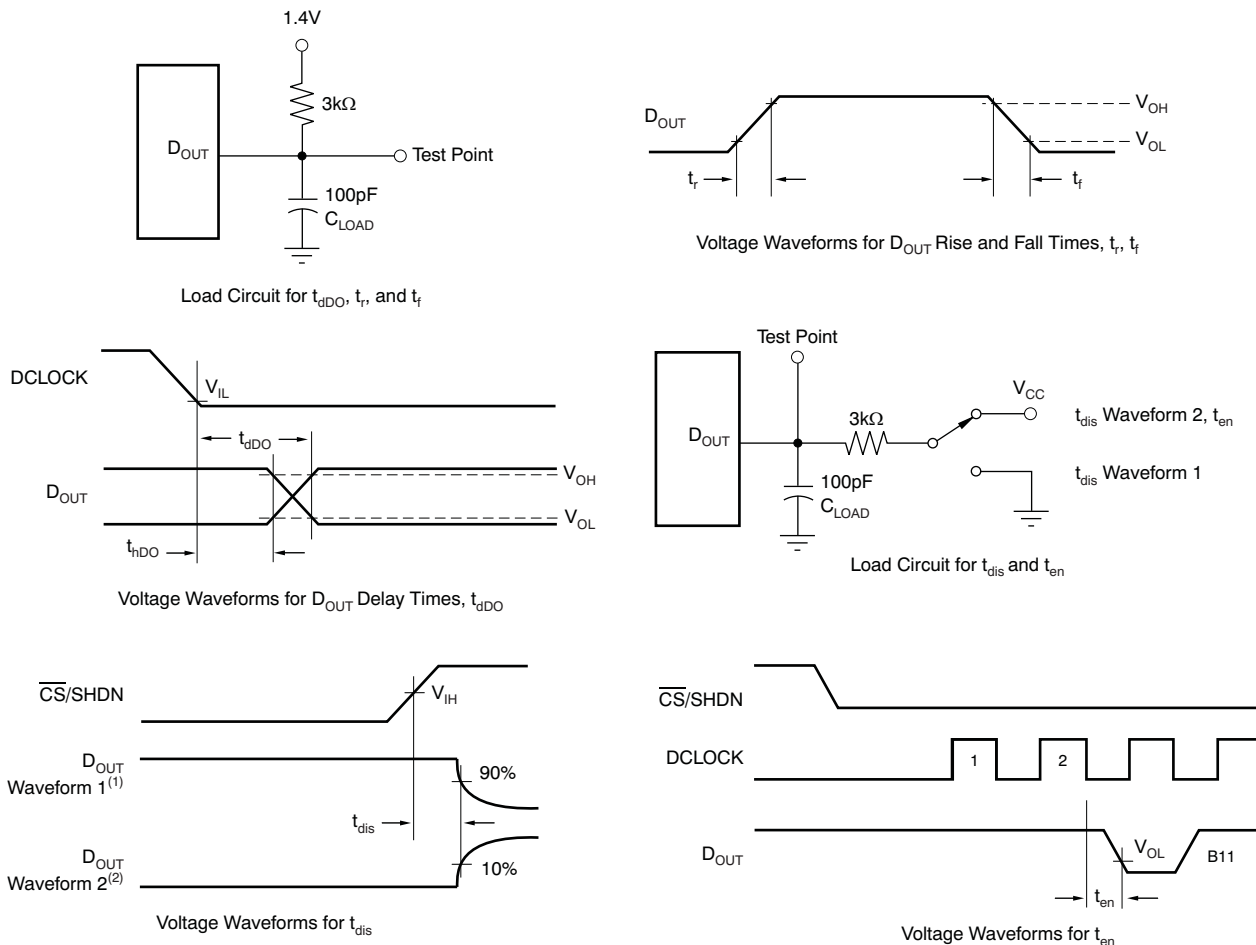
t_{DATA}: During this time, the bias current and the comparator power down and the reference input becomes a high impedance node, leaving the CLK running to clock out LSB-first data or zeroes.

Figure 22. Basic Timing Diagrams

Table 1. Timing Specifications (–40°C to 85°C)

SYMBOL	DESCRIPTION	V_{CC} = 2.7 V			V_{CC} = 5 V			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
t_{SMPL}[1]	Analog input sample time	1.5		2.0	1.5		2.0	Clk Cycles
t_{CONV}	Conversion time		12			12		Clk Cycles
t_{CYC}[1]	Cycle time	16			16			Clk Cycles
t_{CSD}[1]	$\overline{CS}$ falling to DCLOCK low			0			0	ns
t_{SUCS}[1]	$\overline{CS}$ falling to DCLOCK rising	0.03		1000	0.03		1000	µs
t_{hDO}[1]	DCLOCK falling to current D_{OUT} not valid	15			15			ns
t_{dDO}[1]	DCLOCK falling to next D_{OUT} valid		130	200		85	150	ns
t_{dis}[1]	$\overline{CS}$ rising to D_{OUT} high impedance		40	80		25	50	ns
t_{en}[1]	DCLOCK falling to D_{OUT} enabled		75	175		50	100	ns
t_f[1]	D_{OUT} fall time		90	200		70	100	ns
t_r[1]	D_{OUT} rise time		110	200		60	100	ns

(1) Not production tested

Load Circuit for t_{dDO}, t_r, and t_f

Voltage Waveforms for D_{OUT} Rise and Fall Times, t_r, t_f

Voltage Waveforms for D_{OUT} Delay Times, t_{dDO}

Load Circuit for t_{dis} and t_{en}

Voltage Waveforms for t_{dis}

Voltage Waveforms for t_{en}

NOTES: (1) Waveform 1 is for an output with internal conditions such that the output
is HIGH unless disabled by the output control.

(2) Waveform 2 is for an output with internal conditions such that the output
is LOW unless disabled by the output control.

Figure 23. Timing Diagrams and Test Circuits for the Parameters in Table 1

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A falling $\overline{CS}$ signal initiates the conversion and data transfer. The first 1.5 to 2.0 clock periods of the conversion cycle are used to sample the input signal. After the second falling DCLOCK edge, D_{OUT} is enabled and outputs a low value for one clock period. For the next 12 DCLOCK periods, D_{OUT} outputs the conversion result, most significant bit first.

After the least significant bit (B0) has been output, subsequent clocks repeat the output data, but in a least significant bit first format. After the most significant bit (B11) has been repeated, DOUT becomes high impedance. Subsequent clocks have no effect on the converter. A new conversion is initiated only when $\overline{CS}$ is taken high and returned low.

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Data Format

The output data from the ADS7822 is in straight binary format, as shown in Table 2. This table represents the ideal output code for the given input voltage and does not include the effects of offset, gain error, or noise.

Table 2. Ideal Input Voltages and Output Codes

DESCRIPTION	ANALOG VALUE	DIGITAL OUTPUT STRAIGHT BINARY	
		BINARY CODE	HEX CODE
Full-scale range	V_{REF}		
Least significant bit (LSB)	$V_{REF}/4096$		
Full-scale	$V_{REF} - 1$ LSB	1111 1111 1111	FFF
Midscale	$V_{REF}/2$	1000 0000 0000	800
Midscale − 1 LSB	$V_{REF}/2 - 1$ LSB	0111 1111 1111	7FF
Zero	0V	0000 0000 0000	000

POWER DISSIPATION

The architecture of the converter, the semiconductor fabrication process, and a careful design allow the ADS7822 to convert at up to a 75-kHz rate while requiring very little power. Still, for the absolute lowest power dissipation, there are several things to keep in mind.

The power dissipation of the ADS7822 scales directly with conversion rate. So, the first step to achieving the lowest power dissipation is to find the lowest conversion rate that will satisfy the requirements of the system.

In addition, the ADS7822 goes into power-down mode under two conditions: when the conversion is complete and whenever $\overline{CS}$ is high (see Figure 22). Ideally, each conversion should occur as quickly as possible; preferably, at a 1.2MHz clock rate. This way, the converter spends the longest possible time in the power-down mode. This is very important since the converter not only uses power on each DCLOCK transition (as is typical for digital CMOS components), but also uses some current for the analog circuitry, such as the comparator. The analog section dissipates power continuously, until the power-down mode is entered.

Figure 24 shows the current consumption of the ADS7822 versus sample rate. For this graph, the converter is clocked at 1.2 MHz regardless of the sample rate—$\overline{CS}$ is high for the remaining sample period. Figure 25 also shows current consumption versus sample rate. However, in this case, the DCLOCK period is 1/16th of the sample period—$\overline{CS}$ is high for one DCLOCK cycle out of every 16.
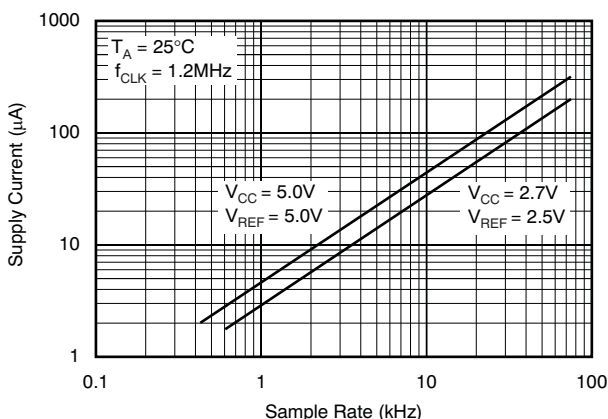

Figure 24. Maintaining f_{CLK} at the Highest Possible Rate Allows the Supply Current to Drop Linearly with the Sample Rate

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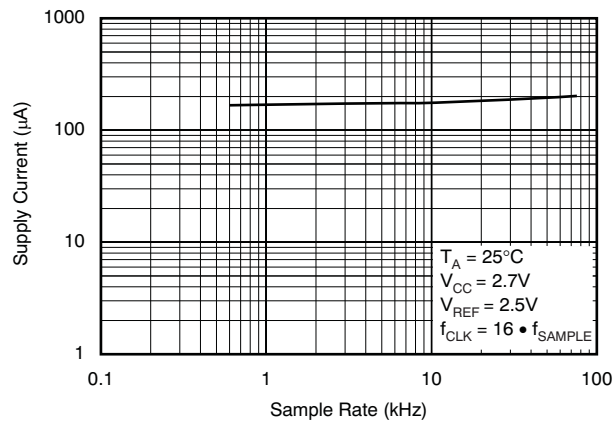
Figure 25. Scaling f_{CLK} Reduces the Supply Current Only Slightly with the Sample Rate

There is an important distinction between the power-down mode that is entered after a conversion is complete and the full power-down mode that is enabled when $\overline{CS}$ is high. While both shut down the analog section, the digital section is completely shutdown only when $\overline{CS}$ is high. Thus, if $\overline{CS}$ is left low at the end of a conversion and the converter is continually clocked, the power consumption will not be as low as when $\overline{CS}$ is high; see Figure 26 for more information.
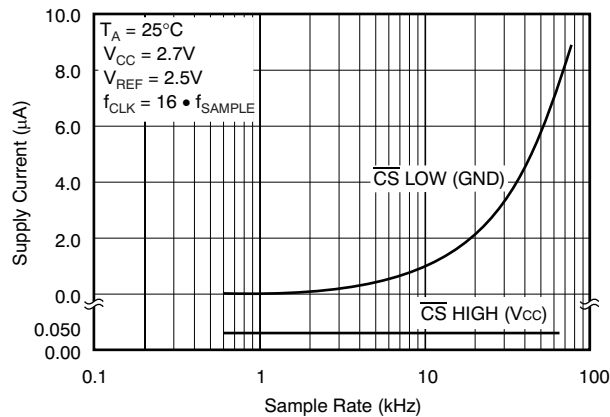
Figure 26. Shutdown Current with $\overline{CS}$ High is Typically 50nA, Regardless of the Clock. Shutdown Current with $\overline{CS}$ Low varies with Sample Rate.

Power dissipation can also be reduced by lowering the power-supply voltage and the reference voltage. The ADS7822 operates over a V_{CC} range of 2.0 V to 5.25 V. It will run up to a 200-kHz throughput rate over a supply range of 4.75 V to 5.25 V; therefore, it can be clocked at up to 3.2 MHz. However, at voltages below 2.7 V, the converter does not run at a 75-kHz sample rate. See the *Typical Characteristic* curves for more information regarding power-supply voltage and maximum sample rate.

Short Cycling

Another way of saving power is to use the $\overline{CS}$ signal to short-cycle the conversion. Because the ADS7822 places the latest data bit on the D_{OUT} line as it is generated, the converter can easily be short-cycled. This term means that the conversion can be terminated at any time. For example, if only eight bits of the conversion result are needed, then the conversion can be terminated (by pulling $\overline{CS}$ high) after the eighth bit has been clocked out.

This technique can be used to lower the power dissipation (or to increase the conversion rate) in those applications where an analog signal is being monitored until some condition becomes true. For example, if the signal is outside a predetermined range, the full 12-bit conversion result may not be needed. If so, the conversion can be terminated after the first *n*-bits, where *n* might be as low as 3 or 4. This results in lower power dissipation in both the converter and the rest of the system, because they spend more time in the power-down mode.

LAYOUT

For optimum performance, care should be taken with the physical layout of the ADS7822 circuitry. This is particularly true if the reference voltage is low and/or the conversion rate is high. At a 75 kHz conversion rate, the ADS7822 makes a bit decision every 830ns. If the supply range is limited to 4.75 V to 5.25 V, then up to a 200-kHz conversion rate can be used, which reduces the bit decision time to 312 ns. That is, for each subsequent bit decision, the digital output must be updated with the results of the last bit decision, the capacitor array appropriately switched and charged, and the input to the comparator settled to a 12-bit level all within one clock cycle.

The basic SAR architecture is sensitive to spikes on the power supply, reference, and ground connections that occur just prior to latching the comparator output. Thus, during any single conversion for an *n*-bit SAR converter, there are *n* windows in which large external transient voltages can easily affect the conversion result. Such spikes might originate from switching power supplies, digital logic, and high-power devices, to name a few. This particular source of error can be very difficult to track down if the glitch is almost synchronous to the converter DCLOCK signal because the phase difference between the two changes with time and temperature, causing sporadic misoperation.

With this in mind, power to the ADS7822 should be clean and well-bypassed. A 0.1-µF ceramic bypass capacitor should be placed as close to the ADS7822 package as possible. In addition, a 1-µF to 10-µF capacitor and a 5-Ω or 10-Ω series resistor can be used to lowpass filter a noisy supply.

The reference should be similarly bypassed with a 0.1-µF capacitor. Again, a series resistor and large capacitor can be used to lowpass filter the reference voltage. If the reference voltage originates from an op amp, be careful that the op amp can drive the bypass capacitor without oscillation (the series resistor can help in this case). Keep in mind that while the ADS7822 draws very little current from the reference on average, there are still instantaneous current demands placed on the external reference circuitry.

Also, keep in mind that the ADS7822 offers no inherent rejection of noise or voltage variation in regards to the reference input. This is of particular concern when the reference input is tied to the power supply. Any noise and ripple from the supply will appear directly in the digital results. While high-frequency noise can be filtered out as described in the previous paragraph, voltage variation due to the line frequency (50 Hz or 60 Hz), can be difficult to remove.

The GND pin on the ADS7822 should be placed on a clean ground point. In many cases, this will be the analog ground. Avoid connecting the GND pin too close to the grounding point for a microprocessor, microcontroller, or digital signal processor. If needed, run a ground trace directly from the converter to the power-supply connection point. The ideal layout will include an analog ground plane for the converter and associated analog circuitry.

APPLICATION CIRCUITS

Figure 27 and Figure 28 show some typical application circuits for the ADS7822. Figure 27 uses an ADS7822 and a multiplexer to provide for a flexible data acquisition circuit. A resistor string provides for various voltages at the multiplexer input. The selected voltage is buffered and driven into V_{REF}. As shown in Figure 27, the input range of the ADS7822 is programmable to 100 mV, 200 mV, 300 mV, or 400 mV. The 100-mV range would be useful for sensors such as the thermocouple shown.

Figure 28 shows a basic data acquisition system. The ADS7822 input range is 0 V to V_{CC}, as the reference input is connected directly to the power supply. The 5-Ω resistor and 1-µF to 10-µF capacitor filter the microcontroller noise on the supply, as well as any high-frequency noise from the supply itself. The exact values should be picked such that the filter provides adequate rejection of the noise.
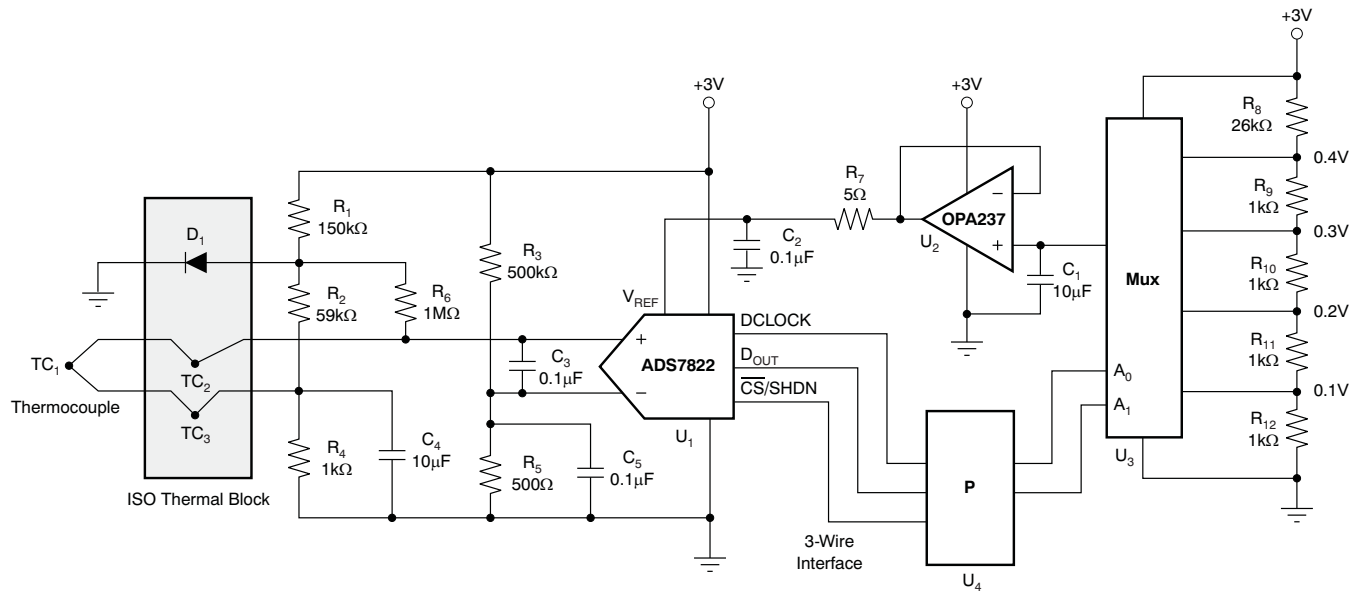
Figure 27. Thermocouple Application Using a Mux to Scale the Input Range of the ADS7822
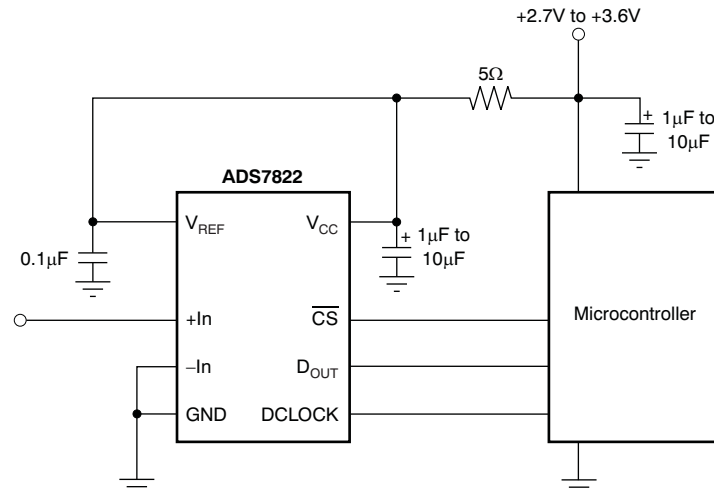

Figure 28. Basic Data Acquisition System

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
ADS7822IDGKRQ1	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR		OCV	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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OTHER QUALIFIED VERSIONS OF ADS7822-Q1 :

● Catalog: ADS7822

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

![Texas Instruments logo]

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADS7822IDGKRQ1	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ADS7822IDGKRQ1	VSSOP	DGK	8	2500	367.0	367.0	35.0

DGK (S−PDSO−G8)   PLASTIC SMALL−OUTLINE PACKAGE

0,65

8   5

0,38
0,25   ⊕ 0,13 Ⓜ

3,10
2,90   5,05
            4,75

1   4

C
3,10
2,90

1,10 MAX   0,15
                    0,05

0,23
0,13

Gauge Plane

0°−8°   0,25

0,70
0,40

Seating Plane

◠ 0,10

4073329/E 05/06

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall
            not exceed 0.15 per end.
        D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
        E. Falls within JEDEC MO−187 variation AA, except interlead flash.

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